

- Designed for TDMA IS-54 Receiver IF Applications
- Low Insertion Loss
- Excellent Selectivity
- Hermetic 13.3 X 6.5 mm Surface-mount Case
- Unbalanced Input and Output
- Complies with Directive 2002/95/EC (RoHS)

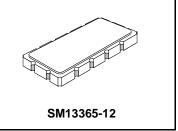
#### Absolute Maximum Ratings

Rating	Value	Units	
Maximum Incident Power in Passband	+10	dBm	
Maximum DC Voltage Between any 2 terminals	30	VDC	
Storage Temperature Range	-40 to +85 °C		
Suitable for Lead-free Soldering - Maximum Soldering Profile	260 °C for 30 s		

# 86.85 MHz

**PX1002** 

# **SAW Filter**



#### **Electrical Characteristics**

Characteristic			Notes	Min	Тур	Max	Units	
Nominal Center Frequency		f <sub>C</sub>	4	86.850			MHz	
Passband	Insertion Loss at fc	IL			3	4.0	dB	
	3 dB Passband	BW3		±12	±25		kHz	
	Amplitude Ripple over fc ±15 kHz		4.0			1.0	dB <sub>P-P</sub>	
	Group Delay Variation over fc ±10 kHz	GDV	1, 2			6.0	µs <sub>P-P</sub>	
Third-Order Intermod.	for -20 dBm tones at fc ±60 & 120 kHz					-95	dBm	
Rejection	fc ±60 kHz			11	16		dB	
	fc -880 kHz to fc -940 kHz		1, 2, 3	65				
	Ultimate				65			
Operating Temperature Range			1	-20		+70	°C	
Impedance Matching to 50 $\Omega$ unbalanced			External L-C					
Case Style		SM13365-12 13.3 X 6.5 mm Nominal Footprint						
Lid Symbolization (YY=year, WW=week) See note 4			RFM PX1002 YYWW					
Standard 7" Reel Quantity			500 units					
Standard 13" Reel Quantity			1000 units					

#### **Electrical Connections**

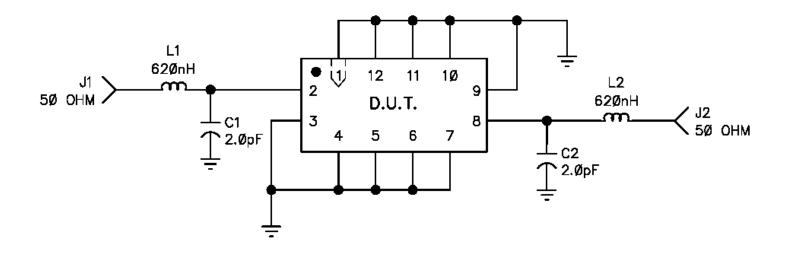
Connection	Terminals
Port 1Hot	2
Port 1 Gnd Return	3
Port 2 Hot	8
Port 2 Gnd Return	9
Case Ground	All Others

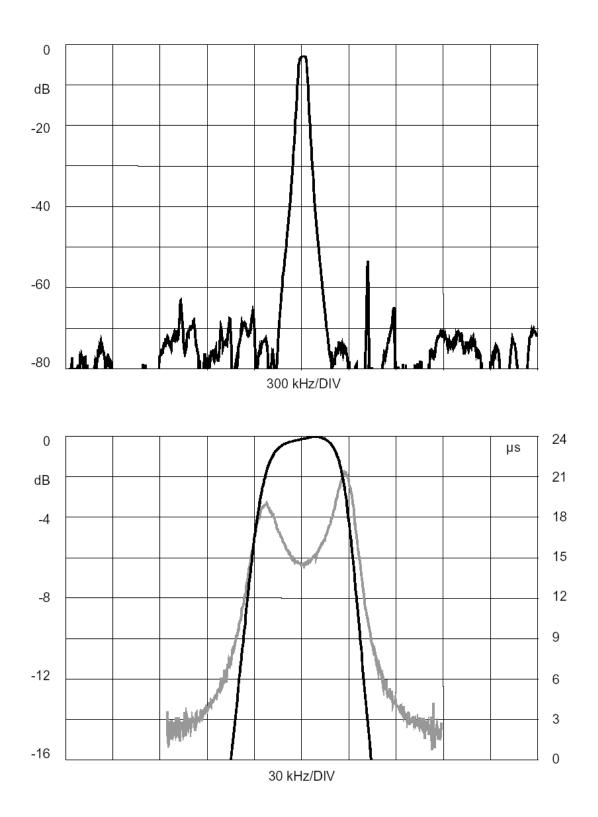
Caution: Electrostatic Sensitive Device. Observe precautions for handling.

#### $\mathbf{F}$ Notes:

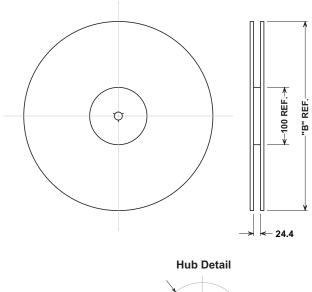
- Unless noted otherwise, all specifications apply over the operating temperature range with filter soldered to the specified demonstration board with impedance matching to 50  $\Omega$  and measured with 50  $\Omega$  network 1. analyzer.
- 2. Unless noted otherwise, all frequency specifications are referenced to the nominal center frequency, fc.
- Rejection is measured as attenuation below the minimum IL point in the 3 passband. Rejection in final user application is dependent on PCB layout and external impedance matching design. See Application Note No. 42
- for details. "LRIP" or "L" after the part number indicates "low rate initial production" 4. and "ENG" or "E" indicates "engineering prototypes."
- 5.
- The design, manufacturing process, and specifications of this filter are subject to change. Either Port 1 or Port 2 may be used for either input or output in the design. 6.
- However, impedances and impedance matching may vary between Port 1 and Port 2, so that the filter must always be installed in one direction per the circuit design.
- 7
- US and international patents may apply. RFM, stylized RFM logo, and RF Monolithics, Inc. are registered trademarks of RF Monolithics, Inc. 8.

# SCHEMATIC, PX1002 (DEMO)

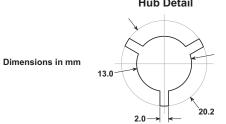




### **Tape and Reel Specifications**

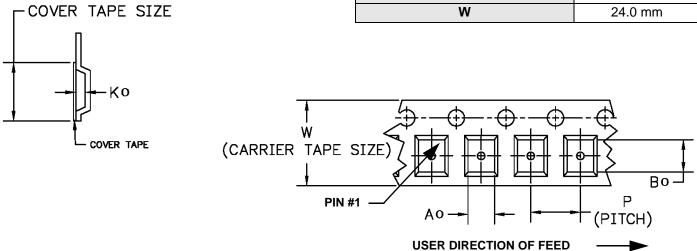


4	'B"	Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000



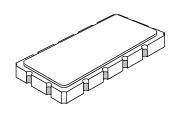
## **COMPONENT ORIENTATION and DIMENSIONS**

Carrier Tape Dimensions			
Ао	7.0 mm		
Во	13.8 mm		
Ко	2.0 mm		
Pitch	12.0 mm		
W	24.0 mm		



# SM13365-12 Case

# 12-Terminal Ceramic Surface-Mount Case 13.3 x 6.5 mm Nominal Footprint



Case Dimensions						
Dimension	mm			Inches		
Min Nom		Max	Min	Nom	Max	
Α	13.08	13.31	13.60	0.515	0.524	0.535
В	6.27	6.50	6.80	0.247	0.256	0.268
С		1.91	2.00		0.075	0.079
D		1.50			0.059	
E		0.79			0.031	
н		1.0			0.039	
Р		2.54			0.100	

Materials			
Solder Pad Plating	0.3 to 1.0 $\mu m$ Gold over 1.27 to 8.89 $\mu m$ Nickel		
Lid Plating	2.0 to 3.0 µm Nickel		
Body	Al <sub>2</sub> O <sub>3</sub> Ceramic		
	Pb Free		

